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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: Nobuyuki SATO

SERIAL NUMBER: 10/814,290

GROUP: 2818

FILED: April 1, 2004

EXAMINER: HUYNH, ANDY

FOR: SEMICONDUCTOR MODULE HAVING HEAT SINK SERVING AS WIRING  
LINE

**REQUEST TO CORRECT TITLE OF INVENTION**

MAIL STOP ISSUE FEE  
COMMISSIONER FOR PATENTS  
P.O. BOX 1450  
ALEXANDRIA, VA 22313-1450

SIR:

In the matter of the above-identified application for patent, we hereby request  
correction of your records to reflect the correct title of the invention. The title of the  
invention should read as follows: SEMICONDUCTOR MODULE **HAVING HEAT SINK  
SERVING AS WIRING LINE.**

Respectfully Submitted,

OBLON, SPIVAK, McCLELLAND,  
MAIER & NEUSTADT, P.C.

  
Marvin J. Spivak

Registration No. 24,913

Joseph Scafetta, Jr.  
Registration No. 26,803

Michael Britton

Registration No. 47,260

Customer Number

**22850**

Tel. (703) 413-3000  
Fax. (703) 413-2220  
(OSMMN 05/04)